



## Product Summary (Typ. @ $V_{GS} = -4.5V$ , $T_A = +25^\circ C$ )

$BV_{DSS}$	$R_{DS(ON)}$	$Q_g$	$Q_{gd}$	$I_D$
-8V	8.2m $\Omega$	8.1nC	1.8nC	-10A

## Description

This 3<sup>rd</sup> generation Lateral MOSFET (LD-MOS) is engineered to minimize on-state losses and switch ultra-fast, making it ideal for high-efficiency power transfer. It uses Chip-Scale Package (CSP) to increase power density by combining low thermal impedance with minimal  $R_{DS(ON)}$  per footprint area.

## Applications

- DC-DC Converters
- Battery Management
- Load Switch

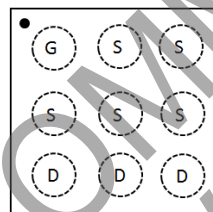
## Features

- LD-MOS Technology with the Lowest Figure of Merit:
  - $R_{DS(ON)} = 8.2m\Omega$  to Minimize On-State Losses
  - $Q_g = 8.1nC$  for Ultra-Fast Switching
- $V_{GS(th)} = -0.8V$  Typ. for a Low Turn-On Potential
- CSP with Footprint 1.5mm x 1.5mm
- Height = 0.60mm for Low Profile
- ESD = 6kV HBM Protection of Gate
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

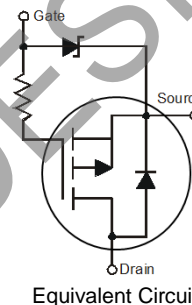
## Mechanical Data

- Case: U-WLB1515-9
- Terminal Connections: See Diagram Below

U-WLB1515-9 (Type B)



Top View  
Pin Configuration



Equivalent Circuit

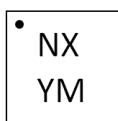
## Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1011UCB9-7	U-WLB1515-9 (Type B)	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

U-WLB1515-9 (Type B)



NX = Product Type Marking Code  
 YM = Date Code Marking  
 Y or  $\bar{Y}$  = Year (ex: G = 2019)  
 M or  $\bar{M}$  = Month (ex: 9 = September)

### Date Code Key

Year	2012	2013	2014	2015	2016	2017	2018	2019
Code	Z	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-8	V
Gate-Source Voltage	V <sub>GSS</sub>	-6	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	T <sub>A</sub> = +25°C -10	A
		T <sub>A</sub> = +70°C -8	
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	T <sub>A</sub> = +25°C -7.4	A
		T <sub>A</sub> = +70°C -6.0	
Pulsed Drain Current (Pulse Duration 10μs, Duty Cycle ≤1%)	I <sub>DM</sub>	-50	A
Continuous Source Pin Current (Note 6)	I <sub>S</sub>	-2	A
Pulsed Source Pin Current (Pulse Duration 10μs, Duty Cycle ≤1%)	I <sub>SM</sub>	-15	A
Continuous Gate Current	I <sub>G</sub>	-0.5	A

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	0.89	W
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.57	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	142.1	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θJA</sub>	80.5	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 7)</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-8	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA
Gate to Source Voltage	BV <sub>GSS</sub>	6	—	—	V	V <sub>DS</sub> = 0V, I <sub>S</sub> = 250μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	-1	μA	V <sub>DS</sub> = -4.0V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	-100	nA	V <sub>GS</sub> = -4.0V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS (Note 7)</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	-0.8	-1.1	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	8.2	10	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2A
		—	10	13		V <sub>GS</sub> = -3.0V, I <sub>D</sub> = -2A
		—	11	14		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2A
Forward Transfer Admittance	Y <sub>fs</sub>	—	16.8	—	S	V <sub>DS</sub> = -4V, I <sub>D</sub> = -2A
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	—	-0.7	-1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -2A
Reverse Recovery Charge	Q <sub>R</sub>	—	6.3	—	nC	V <sub>DD</sub> = -5V, I <sub>F</sub> = -2A,
Reverse Recovery Time	t <sub>RR</sub>	—	18.5	—	ns	di/dt = 200A/μs
<b>DYNAMIC CHARACTERISTICS (Note 8)</b>						
Input Capacitance	C <sub>iss</sub>	—	817	1,060	pF	V <sub>DS</sub> = -4V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	C <sub>oss</sub>	—	595	770	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	—	269	350	pF	
Series Gate Resistance	R <sub>G</sub>	—	1.9	—	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge	Q <sub>g</sub>	—	8.1	10.5	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -4V, I <sub>D</sub> = -2A
Gate-Source Charge	Q <sub>gs</sub>	—	0.9	—	nC	
Gate-Drain Charge	Q <sub>gd</sub>	—	1.8	—	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	—	6.2	10	ns	V <sub>DD</sub> = -4V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2A, R <sub>G</sub> = 10Ω
Turn-On Rise Time	t <sub>R</sub>	—	22.6	—	ns	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	—	30.1	48	ns	
Turn-Off Fall Time	t <sub>F</sub>	—	22.7	—	ns	

- Notes:
5. Device mounted on FR-4 PCB with minimum recommended pad layout.
  6. Device mounted on FR-4 material with 1-inch<sup>2</sup> (6.45cm<sup>2</sup>), 2oz (0.071mm thick) Cu.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to production testing.

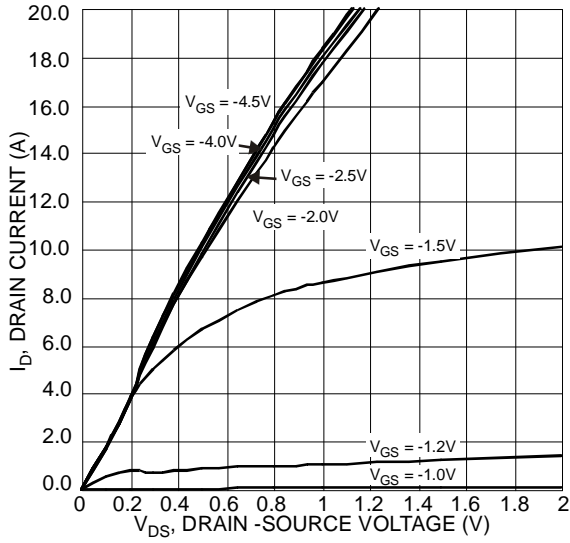


Figure 1 Typical Output Characteristics

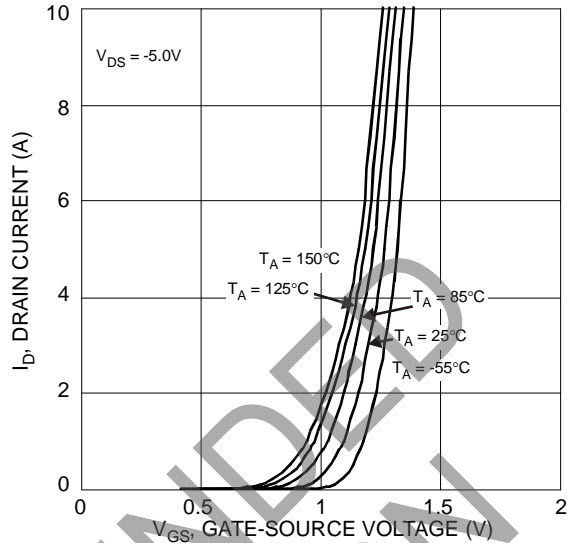


Figure 2 Typical Transfer Characteristics

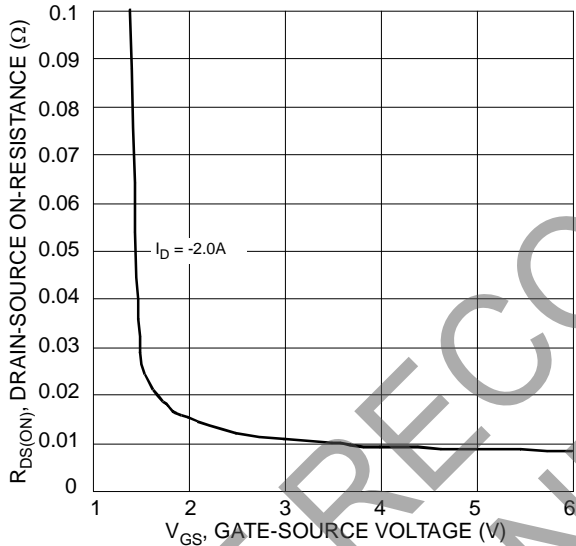


Figure 3 Typical Transfer Characteristic

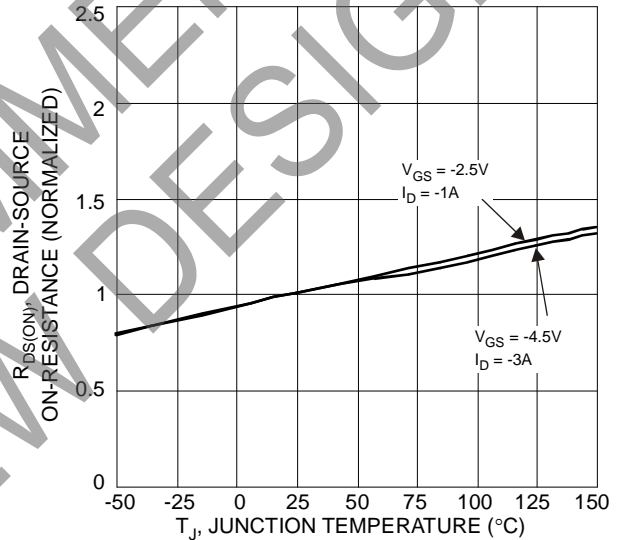


Figure 4 On-Resistance Variation with Temperature

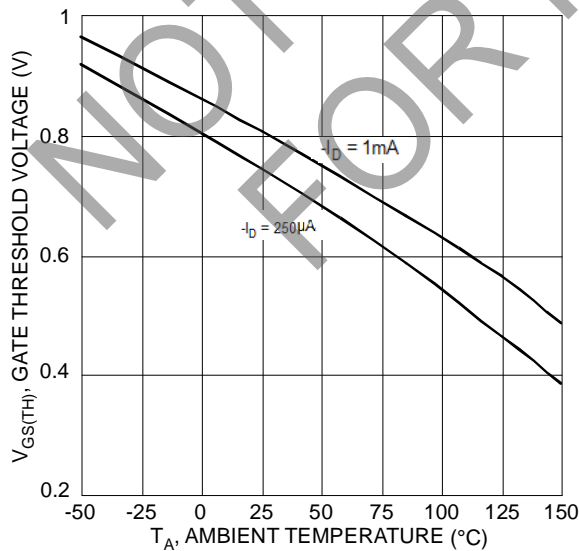


Figure 5 Gate Threshold Variation vs. Ambient Temperature

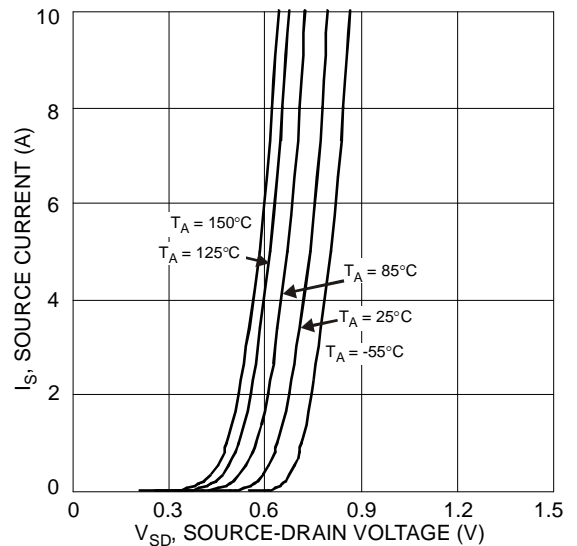
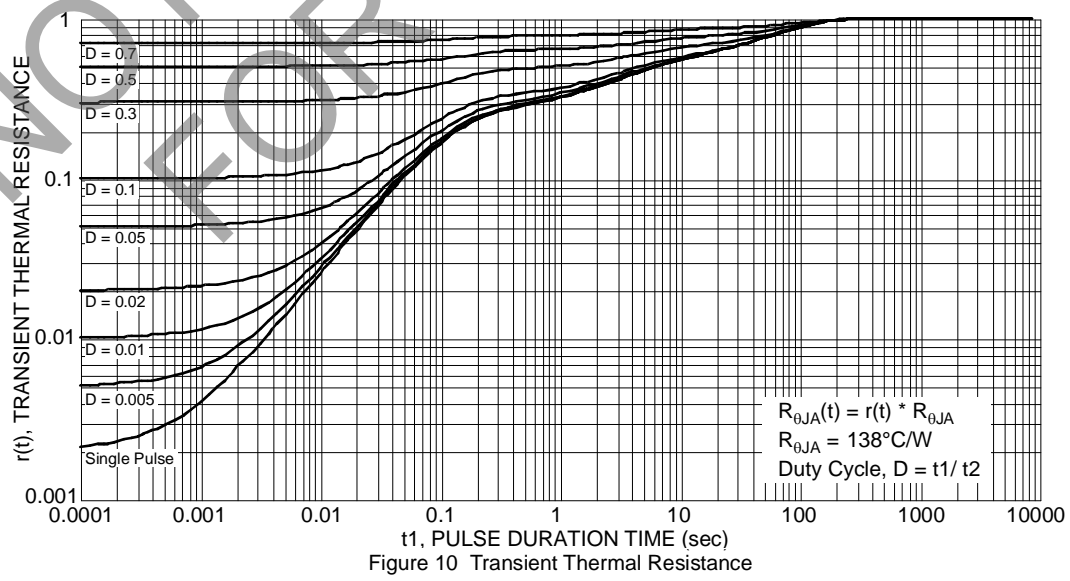
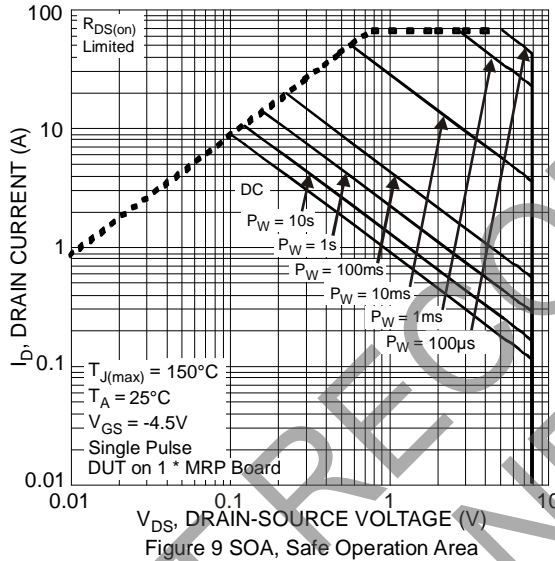
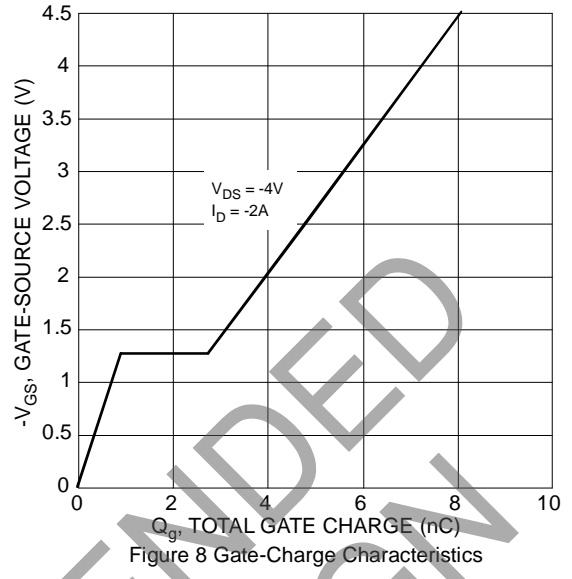
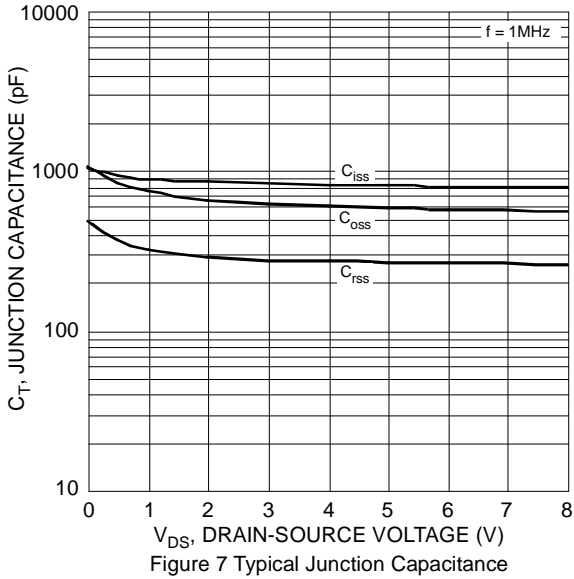


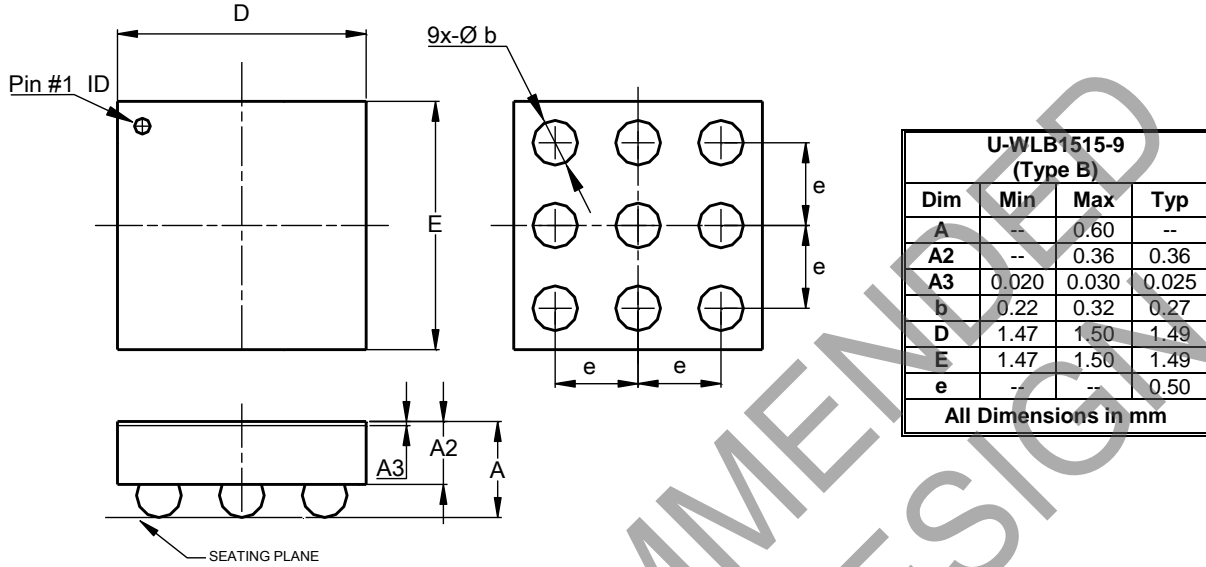
Figure 6 Diode Forward Voltage vs. Current



**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

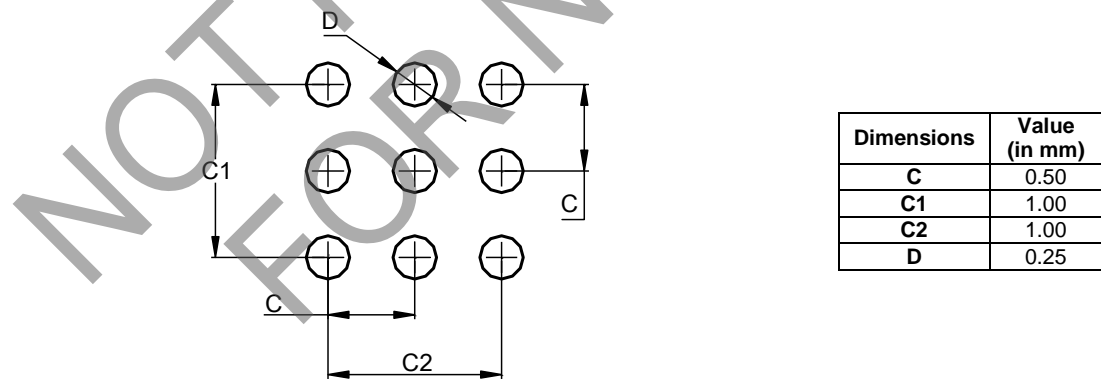
**U-WLB1515-9 (Type B)**



**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**U-WLB1515-9 (Type B)**



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